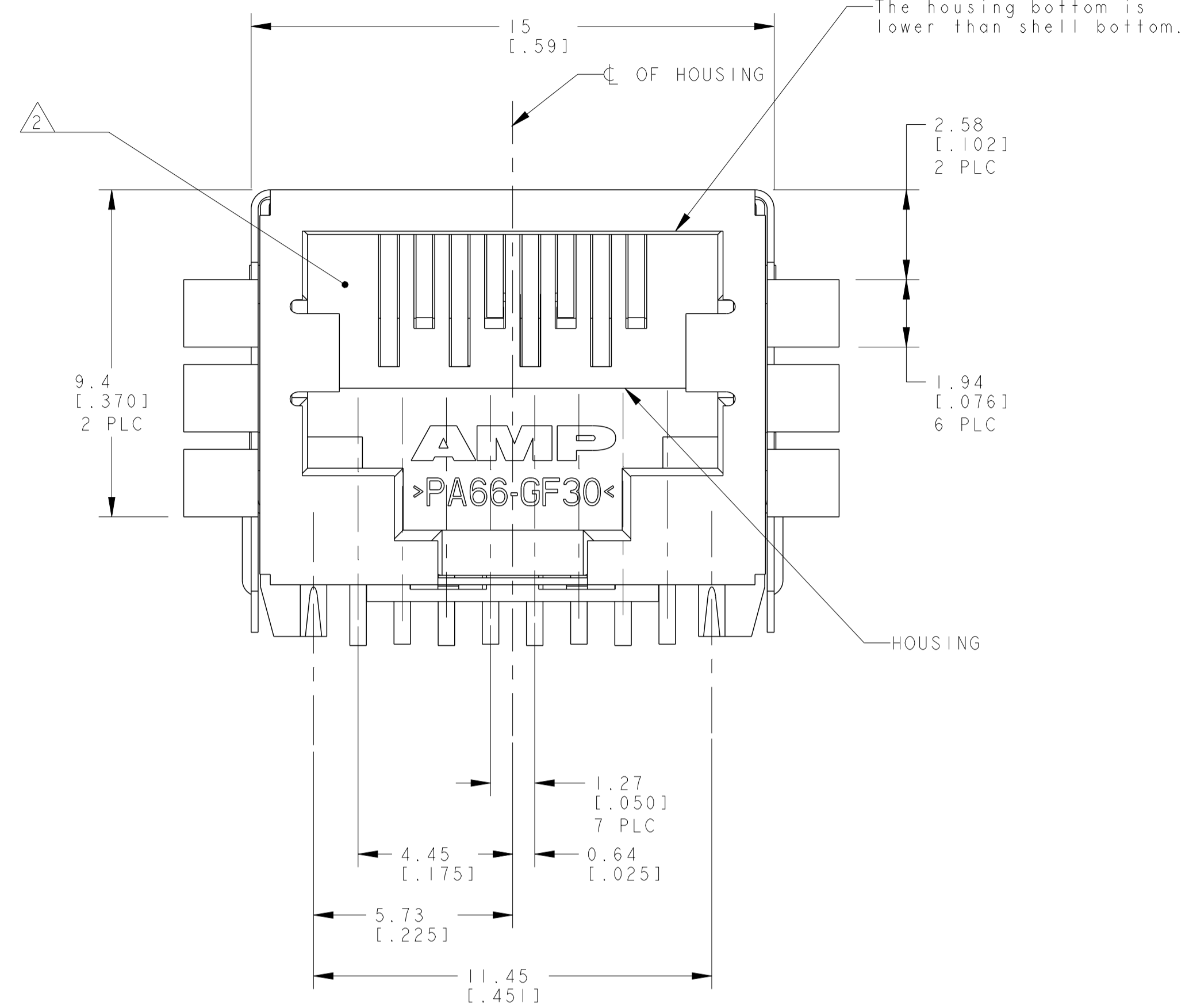
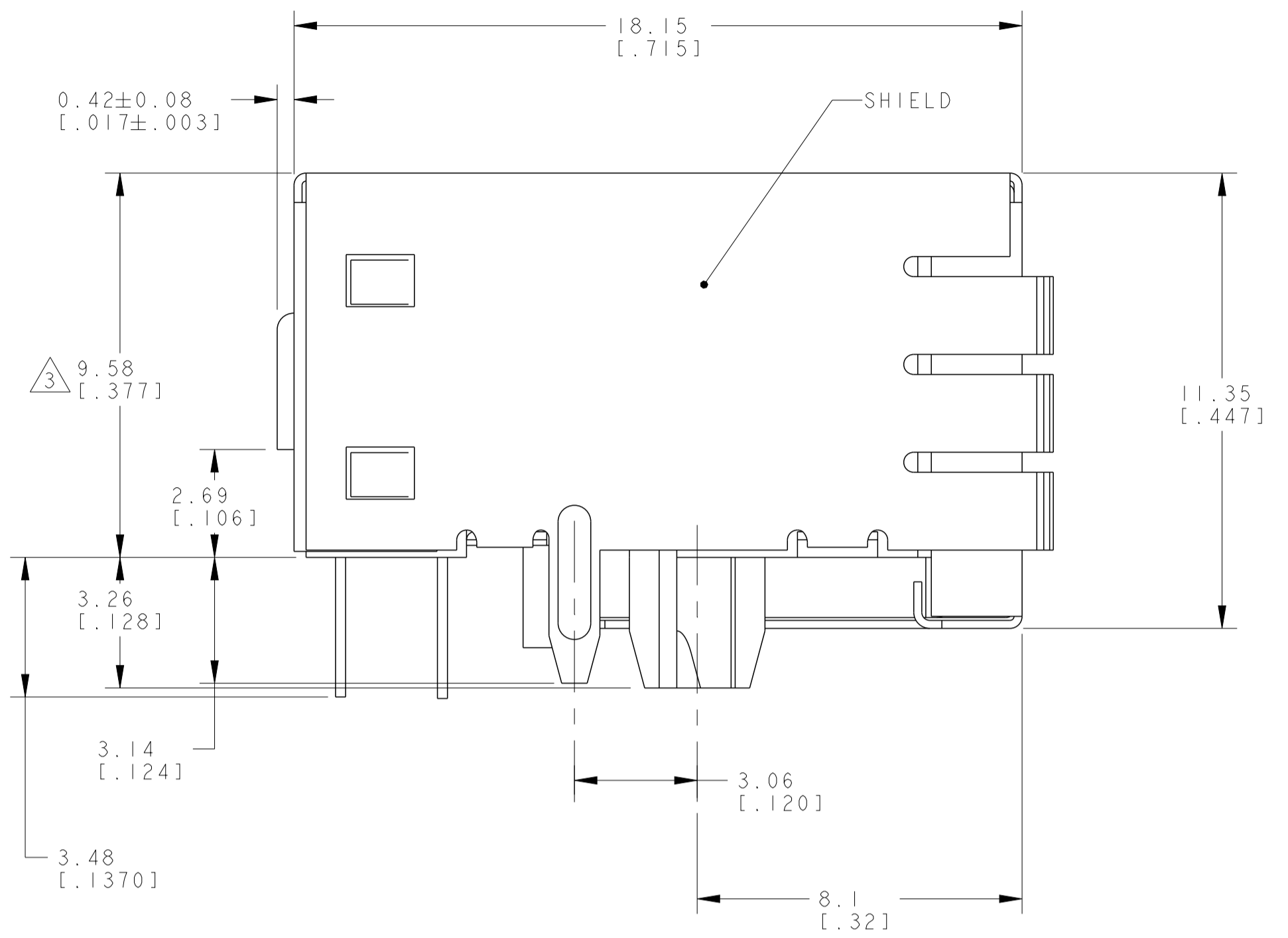
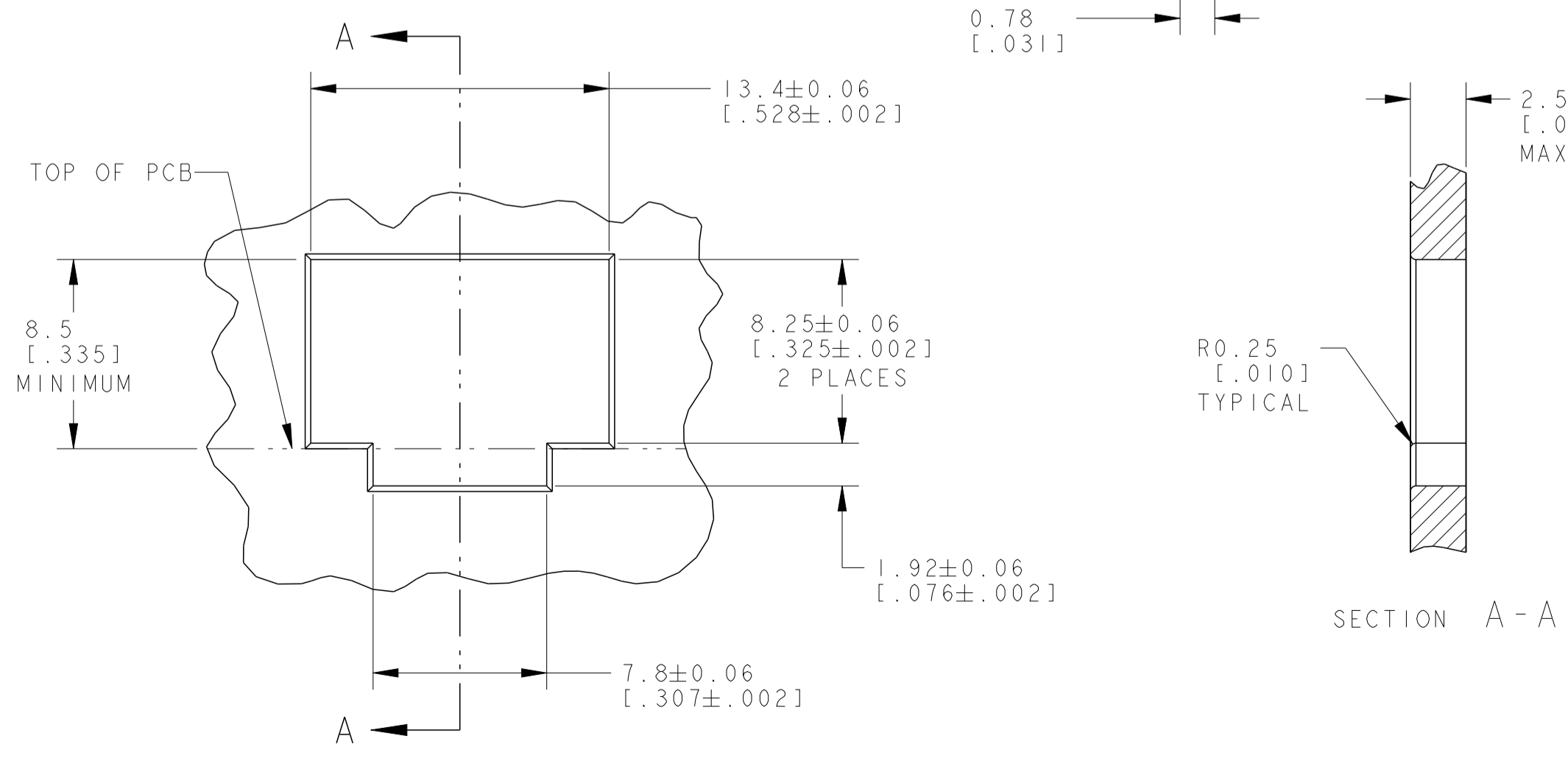
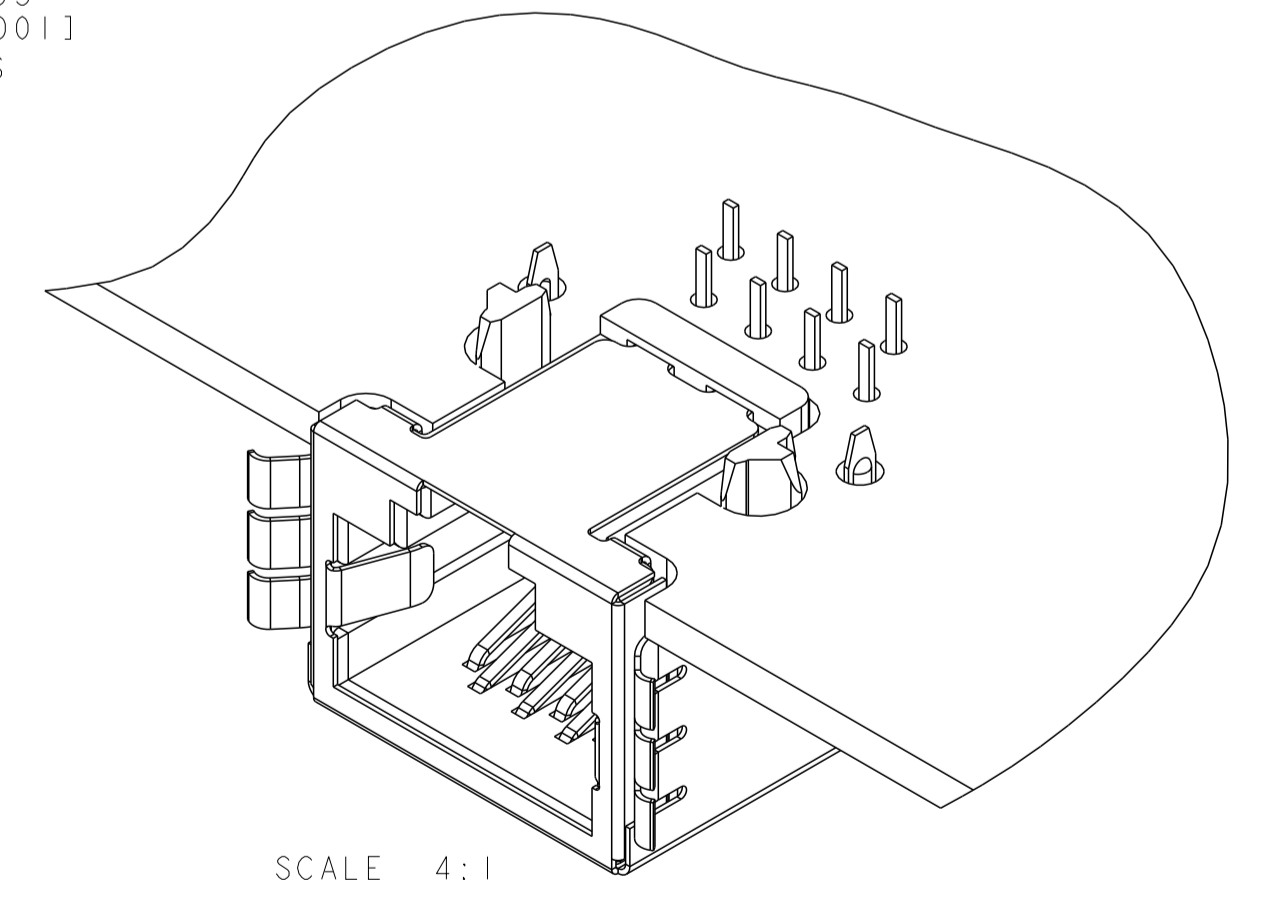
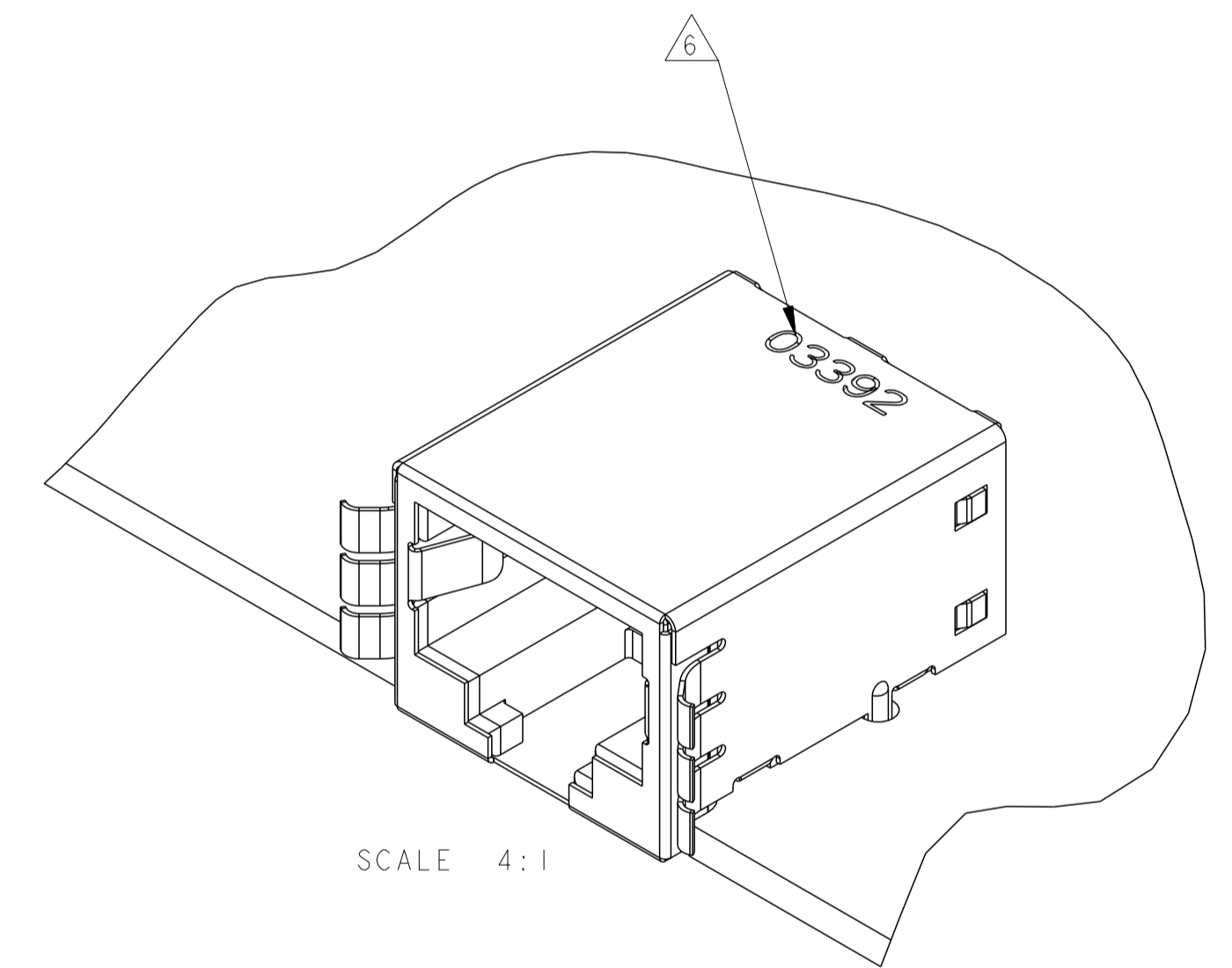
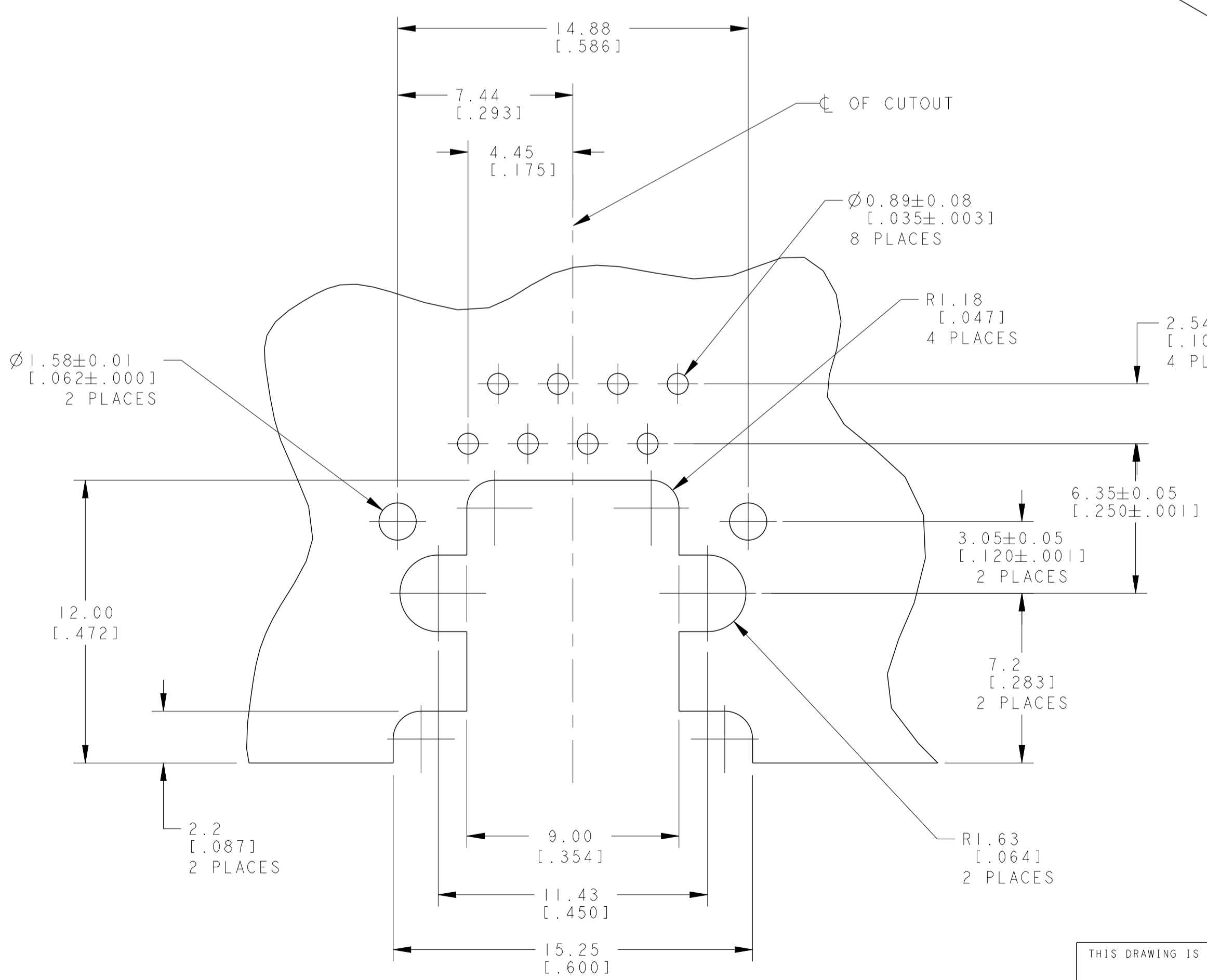
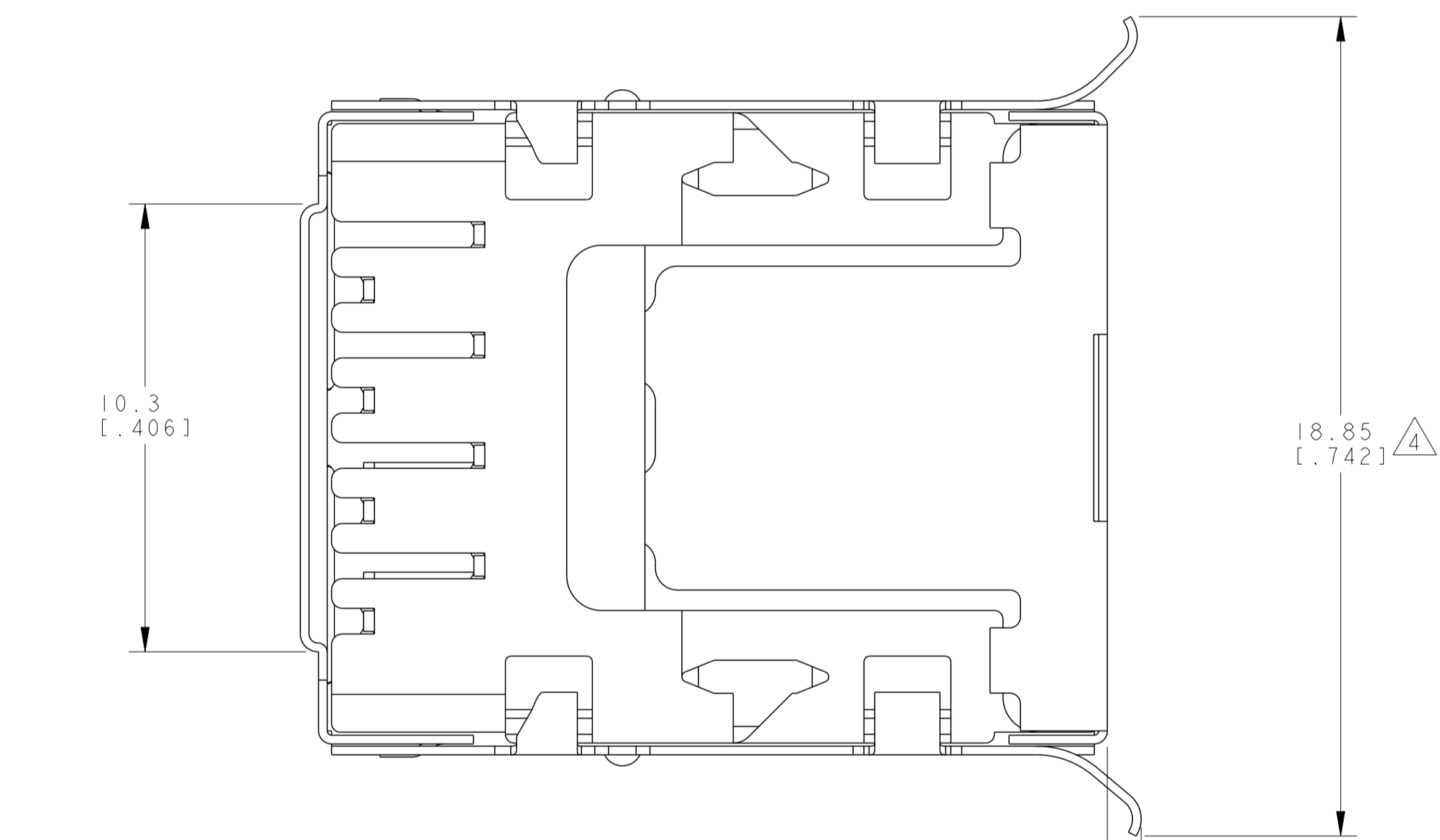


REVISIONS				
P. LTR	DESCRIPTION	DATE	DWN	APVD
B	REVISED PER ECO-14-015233	27APR2015	LL	SH
BI	MODIFIED AS PER ECR-23-169440	05APR2023	KV	HW



- 1 MATERIAL: HOUSING - HIGH TEMPERATURE NYLON, BLACK, UL 94V-0, IR REFLOW SOLDERING PROCESS COMPATIBLE. TERMINALS - 0.25[.010] THICK PHOSPHOR BRONZE PLATED WITH 3.81µm[.000150] MINIMUM THICK MATTE TIN IN SOLDER AREA, 1.27µm[.000050] MINIMUM GOLD IN LOCALIZED PLATE AREA. ENTIRE TERMINAL PLATED WITH 1.27µm[.000050] MINIMUM THICK NICKEL. SHIELD - 0.1[.0039] MIN THICK COPPER ZINC ALLOY, PREPLATED WITH 1.27µm[.000050]min THICK NICKEL AND HOT TIN DIP ON PCB GROUND TABS.
- 2 JACK CAVITY CONFORMS TO FCC RULES AND REGULATIONS PART 68, SUBPART F.
- 3 THIS DIMENSION REPRESENTS THE TOTAL HEIGHT OF THE CONNECTOR FROM THE TOP OF THE PC BOARD.
- 4 THIS DIMENSION HAS A MAXIMUM VALUE OF 20.50[.807] WHEN JACK IS INSTALLED BEHIND PANEL.
- 5. PACKAGED 66 ASSEMBLIES PER PVC TRAY, 396 PER BOX.
- 6 MANUFACTURING DATE CODE: ORIENTED AND LOCATED APPROXIMATELY AS SHOWN. LASER PRINTING. TEXT HEIGHT APPROXIMATELY 2MM. FIRST 2 DIGITS = LAST 2 DIGITS OF YEAR NEXT 2 DIGITS = MANUFACTURING WORK WEEK LAST DIGIT = DAY OF WEEK WITH SUNDAY = 1



SUGGESTED PANEL CUTOUT SCALE 4:1

SUGGESTED PRINTED CIRCUIT BOARD LAYOUT COMPONENT SIDE SCALE 6:1

THIS DRAWING IS A CONTROLLED DOCUMENT.		DWN: RINSEN_SUN 28MAY2010	1932626-1	
DIMENSIONS: mm [ INCHES ]		CHK: SUNY_ZHAO 28MAY2010	MATERIAL / FINISH	
TOLERANCES UNLESS OTHERWISE SPECIFIED:		APVD: STEVEN_YAO 28MAY2010	PART NUMBER	
0 PLC ±	1 PLC ±	PRODUCT SPEC	1932626-1	
2 PLC ±0.131(.005)	3 PLC ±	108-1163	TE Connectivity	
4 PLC ±	ANGLES ±	APPLICATION SPEC	MODULAR JACK ASSEMBLY, 8 POSITION, SHIELDED, 10mm	
MATERIAL: SEE P/N TABLE	FINISH: SEE P/N TABLE	114-2048	SIZE: A1	
WEIGHT: 3.49 grams		CAGE CODE: -	DRAWING NO: C=1932626	
CUSTOMER DRAWING		SCALE: 8:1	SHEET 1 OF 1	